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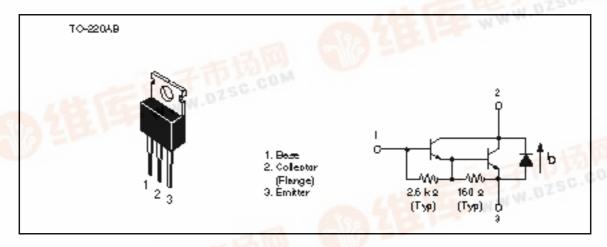
Silicon NPN Triple Diffused

HITACHI

Application

Low frequency power amplifier

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item WWW.	Symbol	Ratings	Unit	
Collector to base voltage	$V_{\sf CBO}$	120	V	
Collector to emitter voltage	V_{CEO}	120	V	
Emitter to base voltage	V_{EBO}	7	V	
Collector current	I _c	6	A	
Collector peak current	C(peak)	12	А	
Collector power dissipation	P _c *1	40	W	
Junction temperature	and Ti	150	°C	
Storage temperature	Tstg	-55 to +150	°C	
C to E diode forward current	l _D *1	6	А	

Note: 1. Value at $T_c = 25$ °C.

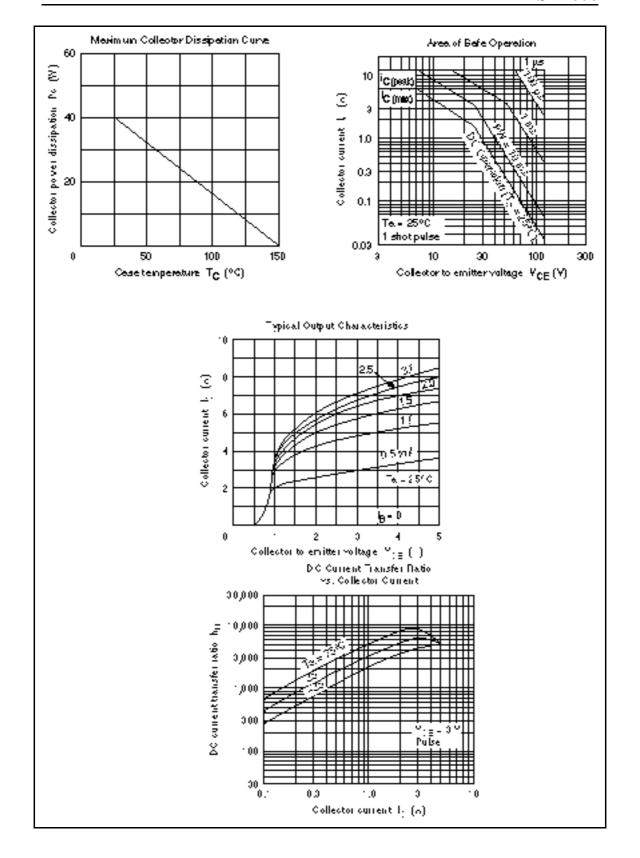


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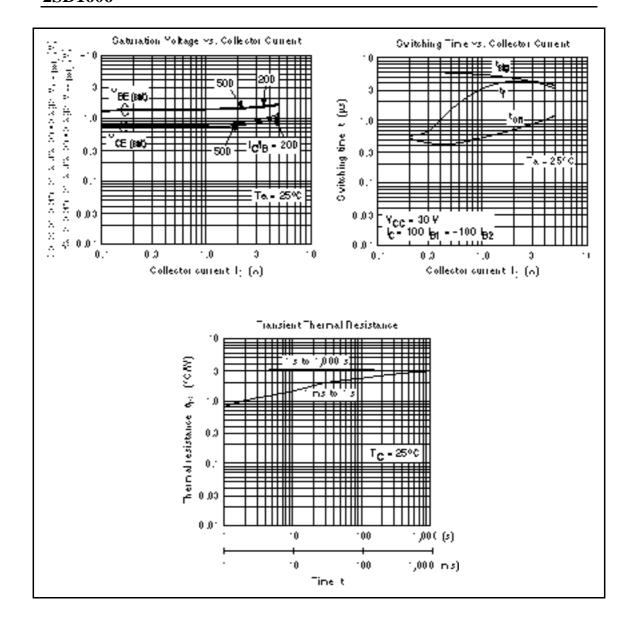
Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	120	_	_	V	$I_{\rm C}$ = 25 mA, $R_{\rm BE}$ =
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	_	_	V	$I_{\rm E} = 50 \text{mA}, I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	100	μΑ	$V_{CB} = 120 \text{ V}, I_{E} = 0$
	I _{CEO}	_	_	10	μΑ	$V_{CE} = 100 \text{ V}, R_{BE} =$
DC current transfer ratio	h _{FE}	1000	_	20000		$V_{CE} = 3 \text{ V}, I_{C} = 3 \text{ A}^{*1}$
Collector to emitter saturation	$V_{\text{CE(sat)1}}$	_	_	1.5	V	$I_{\rm C} = 3 \text{ A}, I_{\rm B} = 6 \text{ mA}^{*1}$
voltage	V _{CE(sat)2}	_	_	3.0	V	$I_{\rm C} = 6 \text{ A}, I_{\rm B} = 60 \text{ mA}^{*1}$
Base to emitter saturation	$V_{BE(sat)1}$	_	_	2.0	V	$I_{\rm C} = 3 \text{ A}, I_{\rm B} = 6 \text{ mA}^{*1}$
voltage	$V_{BE(sat)2}$	_	_	3.5	V	$I_{\rm C} = 6 \text{ A}, I_{\rm B} = 60 \text{ mA}^{*1}$
C to E diode forward voltage	$V_{\scriptscriptstyle D}$	_	_	3.0	V	$I_{D} = 6 A^{*1}$
Turn on time	t _{on}	_	0.6	_	μs	$I_{\rm C} = 3 \text{ A}, I_{\rm B1} = -I_{\rm B2} = 6 \text{ mA}$
Storage time	t _{stg}	_	7.0	_	μs	_
Fall time	t _f	_	2.0	_	μs	

Note: 1. Pulse test.



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HITACHI

Histochi, Ltd.
Semiconductor & IC Div.
Neppon Bidg, 2-6-2, Ohte-medii, Chiyode-ku, Tokyo 100, Jepan Tet Tokyo (03, 3270-2111
Fex: (03, 3270-5109)

For further in forme Ilon write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Briabana, CA. 94005-4835 U.S.A. Tab. A.E. 1990 2000

Tet 415-589-8300 Fex: 415-583-4207 Hitschi Burope GmbH
Bectronic Components Group
Continental Burope
Dornscher Streiße 3
D-85622 Feldkirchen
München
Tet 089-9 94 80-0
Fex 089-9 20 30 00

Hitachi Burope Ltd.
Bedronic Componente Div.
Northern Burope Headquertere
Whitebrook Perk
Lower Cook ham Road
Maidenhead
Berkehire SL68YA
Urited Kingdom
Tet 0628-585000
Fex: 0628-778322

Hitachi Asia Pta, Ltd 45 Collyer Quay \$20-00 Hitachi Towar Singapore 0404 Tat 535-2400 Fex: 535-1533

Hitachi Asia (Hong Kong) Ltd. Unit 705, North Towar, World Finance Cantra, Harbour City, Carton Road Taim Sha Taul, Kowloon Hong Kong Tat 27:592/18 Fax: 27:306074